

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5088086

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	ABHIJIT BASU MALLICK	06/14/2018
	PRAMIT MANNA	06/14/2018
	SHISHI JIANG	06/14/2018
RECEIVING PARTY DATA		
Name:	APPLIED MATERIALS, INC.	
Street Address:	3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15946107	
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Email:	lmurphy@dsiplaw.com	
Correspondent Name:	SERVILLA WHITNEY LLC	
Address Line 1:	33 WOOD AVENUE SOUTH	
Address Line 2:	SUITE 830	
Address Line 4:	ISELIN, NEW JERSEY 08830	
ATTORNEY DOCKET NUMBER:	024909US01	
NAME OF SUBMITTER:	JEFFREY I. BLANKMAN	
SIGNATURE:	/Jeffrey I. Blankman, Reg. #57826/	
DATE SIGNED:	08/08/2018	
Total Attachments: 2		
source=00746404#page1.tif		
source=00746404#page2.tif		

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors

1)	Abhijit Basu Mallick 2637 Alma Street Palo Alto, CA, 94306 United States of America
2)	Pramit Manna 299 W. Washington Ave. # 421 Sunnyvale, CA, 94086 United States of America

3)	Shishi Jiang 3229 El Camino Real, #308 Santa Clara, CA, 95051 United States of America
----	---

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"Gapfill Using Reactive Anneal"

for which application for Letters Patent in the United States was filed on April 5, 2018,

under Serial No. 15946107, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, CA, 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.


2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications,

declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1) 06/14/, 2018 
(INVENTOR) Abhijit Basu Mallick

2) 06/14, 2018 
(INVENTOR) Pramit Manna

3) 6/14, 2018 
(INVENTOR) Shishi Jiang